

Attachment No. 2

Minutes of the CE-2.9 Subcommittee on Sockets 28 – 29 September 2006 Reno, NV

Facilitator Carl Fritz welcomed everyone, and said that the meeting would be conducted following the published agenda.

It is noted that all actions taken by the subcommittees will be simultaneously approved by the CE-2.0 committee.

1. Approval of the 24 – 25 April 2006 Minutes

1. The minutes of the 24 – 25 April 2006 meeting in Ft. Lauderdale, FL was approved. Moved by Bob Druckenmiller and seconded by Ralph Antonelli. The motion was unanimously moved and approved.

2. SPECIFICATIONS BY PROJECT NUMBERS

A. SP-4965: Rev. EIA-540B0AE: Detail Land Grid Array (Contech Research is sponsor)

To be reviewed when EIA-364-1003, Ball Grid Array (BGA) and Land Grid Array (LGA) Test Sequence for Electrical Connectors and Sockets is developed.

B. SP-4970: EIA-540DAAA-A: Detail, DIP

It was reported that the specification is at EDEC for approval.

C. SP-4971: EIA-700A0AB: 68-pin Memory Card Connector

It was reported that the specification is at EDEC for approval.

D. SP-4973: EIA-540B0AB: Low Pin Count BGA

To be reviewed when EIA-364-1003, Ball Grid Array (BGA) and Land Grid Array (LGA) Test Sequence for Electrical Connectors and Sockets is developed.

E. SP-4982-1: EIA-5400000A: Generic

Carl reported that a second letter was sent to EIA for EDEC ballot (mccwil268) on 14 August 2006.

F. SP-5055: Replacement document for EIA-676-A Detail, SFF 1.8 inch (45.7 mm) Disk Drives

It was reported that the standard published June 2006.

Attachment No. 2

G. SP-5056: EIA-674: Detail, SFF 1.8" Disk Drives

It was reported that the standard was published August 2006.

H. SP-5058-A: EIA-720-A: Detail, SFF 2.5" Disk Drives

It was reported that the final ballot count from Cecelia Yates (EIA staff) on 15 August 2006 was 5 approvals now and 3 abstentions, and that a letter (mccwil27269) was sent to Cecelia Yates (EIA Staff) EDEC ballot on 15 August 2006.

I. SP-5059: EIA-677: Detail, SFF Power Connector Pin Dimensions

It was reported that a final ballot count from Cecelia Yates (EIA staff) following the meeting April meeting indicated that 6 approvals were received and no comments. As a result there were a sufficient number of ballots received and a second letter from the committee was not necessary. The standard was sent to EDEC for processing using the letter to Cecelia (mccwil216) dated 11 October 2005. The standard was published as reaffirmed 4 August 2006.

J. SP-5112 as follows:

- EIA-700A0AC: Detail, 88-pin DRAM Connector
- EIA-540A000-A: Sectional, Chip Carrier Sockets
- EIA-540AA00: Blank, Leadless Chip Carrier Sockets
- EIA-540AAAA: Detail, Type A Chip Carrier Sockets
- EIA-540AB00: Blank, PQFP
- EIA-540ABAA: Detail, PQFP
- EIA-540AC00: Blank, PCC
- EIA-540ACAA: Detail, PCC
- EIA-540AD00: Blank, Adaptor QFP to PGA
- EIA-540B000: Sectional, PGA
- EIA-540BA00: Blank, PGA
- EIA-540BAAB: Detail, Non-Mechanical PGA
- EIA-540BAAC: Detail, Flex Carrier PGA
- EIA-540D000-A: Sectional, In-Line Packages
- EIA-540DA00: Blank, DIP (Will be sent out for review)
- EIA-540DAAB: Detail, Flex Carrier DIP
- EIA-540EA00: Blank, Round Sockets
- EIA-540EAAA: Detail, Round Sockets
- EIA-540F000: Sectional, Multi-Package Modules

It was reported that a second letter (mccwil269) was sent to Cecelia Yates (EIA Staff) EDEC ballot on 14 August 2006.

Attachment No. 2

K. SP-5114 as follows:

- 540C000: Sectional Relay Sockets
- 540CA00: Blank, Relay Sockets
- 540CAAA: Detail, 10A Relay Socket
- 540CAAB: Detail, 5A Relay Socket

It was reported that a second letter (mccwil269) was sent to Cecelia Yates (EIA Staff) EDEC ballot on 14 August 2006.

3. SPECIFICATIONS AWAITING PROJECT NUMBERS

A. EIA-364-1003, Ball Grid Array (BGA) and Land Grid Array (LGA) Test Sequence for Electrical Connectors and Sockets (Contech Research, Tom Peel)

It was agreed to establish a working group to determine if this document can be made part of EIA-364-1000 or should be developed as a stand alone document. John Healey, Bob Druckenmiller, Arnold Offner and Frank Ruffino agreed to participate in the working group. Carl to e-mail the draft to John, Bob, Arnold and Frank.

4. NEW BUSINESS

There was no new business.

Prepared by
Carl Fritz, Facilitator, CE-2.9